

概述 Description

HL3120 是一种输出电流为 2.5A 的栅极驱动光电耦合器，具有一个砷化铝镓（AlGaAs）的发光二极管，通过红外光耦合到光敏集成电路。这种光电耦合器可驱动大多数的小功率 IGBTs 和 MOSFETs。在电机控制逆变器以及高性能电力系统应用中，其非常适用于快速切换驱动功率 IGBTs 和 MOSFETs。

The HL3120 is a gate driven optocoupler with an output current of 2.5 A, with an AlGaAs LED, which is coupled to a photosensitive integrated circuit through infrared light. This optocoupler can drive most low-power IGBTs and MOSFETs. In the motor control inverter and high-performance power system applications, it is very suitable for fast switching drive power IGBTs and MOSFETs.

特性 Features

- 35kV/us 最小共模抑制  
35kV / us minimum Common Mode Rejection
- 2.5A 最大峰值输出电流  
2.5A maximum peak output current
- 2.0A 最小峰值输出电流  
2.0A minimum peak output current
- 宽工作电压范围: 15V 至 30V  
Wide operating  $V_{CC}$  Range: 15V~30V
- 最大传播延迟时间为 400ns  
400ns maximum propagation delay
- 100ns 的脉宽失真  
100ns of pulse width distortion
- 迟滞后的欠压闭锁  
Undervoltage locking with hysteresis
- 工作温度范围: -40°C to +100°C  
Operating temperature range: -40°C ~ +110°C
- 符合加强绝缘标准  
Meet reinforced insulation standards

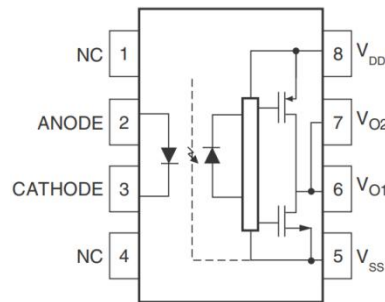
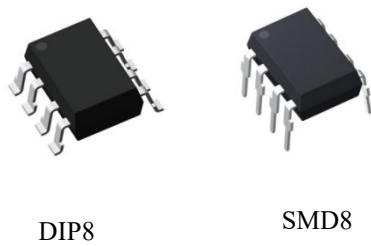
应用 Applications

- 不间断电源  
Uninterrupted Power Supply
- LGBT 隔离/功率 MOSFET 栅极驱动  
LGBT isolation / power MOSFET gate drive
- 感应加热  
Eddy-current heating
- 工业逆变器  
Industrial inverters

真值表 Truth table

| LED | $V_{CC}-V_{SS}$<br>" POSITIVE<br>GOING"<br>(TURN-ON) | $V_{CC}-V_{SS}$<br>"NEGATIVE<br>GOING"<br>(TURN-OFF) | VO         |
|-----|------------------------------------------------------|------------------------------------------------------|------------|
| OFF | 0~30V                                                | 0~30V                                                | LOW        |
| ON  | 0~11.5V                                              | 0~10V                                                | LOW        |
| ON  | 11.5~13.5V                                           | 10~12V                                               | TRANSITION |
| ON  | 13.5~30V                                             | 12~30V                                               | HIGH       |

### 封装和原理图 Package and Schematic Diagram



#### Pin Configuration

- 1. 4 NC
- 2. Anode
- 3. Cathode
- 5. VSS
- 6. VO2
- 7. VO1
- 8. VDD

注意：在引脚 5 和 8 之间必须连接一个 0.1uF 的旁路电容器。

Note: 0.1uF bypass capacitor must be connected between pins 5 and 8.

### 产品型号命名规则 Order Code

## HL 3120 - UN Y - W (V) (ZZ)

- ①
- ②
- ③
- ④
- ⑤
- ⑥
- ⑦

① 公司代码 Company Code (HL: 鸿利鲲鹏 HongliKunpeng)

② 产品系列 Product Series (3120)

③ 框架类型 Lead Frame (Cu: 铜框架 Copper)

④ 树脂类型 Epoxy (H: 无卤 Halogen-free, L: 有卤/无铅 Halogen/Lead-free)

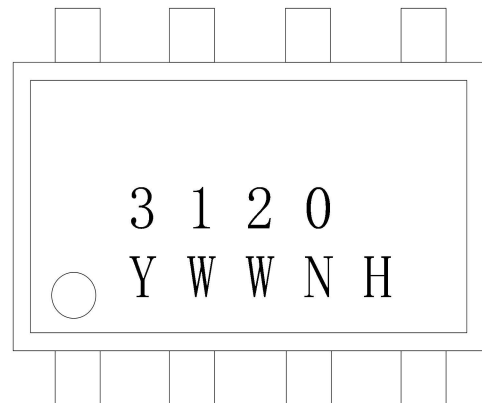
⑤ 封装形式 Package (S: SMD)

⑥ 器件工作温度范围 Device Operating Temperature Range (特殊范围需填或者空白 Special Range need to be filled in or left blank)

⑦ 内部补充代码 Internal Supplementary Code (数字或者空白 Number or None)

### 印字信息 Marking Information

- 印字中“Y”代表年份：A(2018), B(2019), C(2020).....  
“Y”denotes YEAR: A(2018), B(2019), C(2020).....
- 印字中“WW”代表周号  
“WW”denotes Week’s number
- 印字中“N”代表星期几  
“N”denotes the day of the week
- 印字中的“H”代表无卤，而当产品有卤/无铅时，此处空白  
“H”denotes Halogen-free, when the product has halogen/lead-free, leave this blank.



## 绝缘和安规信息 Insulation and Safety related specifications

| 项目<br>Item                            | 符号<br>Symbol | 数值<br>Value | 单位<br>Unit | 备注<br>Note                                                                                                  |
|---------------------------------------|--------------|-------------|------------|-------------------------------------------------------------------------------------------------------------|
| 爬电距离<br>Creepage Distance             | L            | $\geq 7$    | mm         | 从输入端到输出端，沿本体最短距离路径<br>Measured from input terminals to output terminals, shortest distance path along body. |
| 电气间隙<br>Clearance Distance            | L            | $\geq 7$    | mm         | 从输入端到输出端，通过空气的最短距离<br>Measured from input terminals to output terminals, shortest distance through air.     |
| 绝缘距离<br>Insulation Thickness          | DTI          | $\geq 0.4$  | mm         | 发射器和探测器之间的绝缘厚度<br>Insulation thickness between emitter and detector.                                        |
| 峰值隔离电压<br>Peak Isolation Voltage      | $V_{IORM}$   | 1500        | $V_{peak}$ | DIN/EN/IEC EN60747-5-5.                                                                                     |
| 瞬态隔离电压<br>Transient Isolation Voltage | $V_{IOTM}$   | 7000        | $V_{peak}$ | DIN/EN/IEC EN60747-5-5.                                                                                     |
| 隔离电压<br>Isolation Voltage             | $V_{ISO}$    | 5000        | $V_{rms}$  | For 1 min                                                                                                   |

极限参数 Absolute Maximum Ratings ( $T_A=25^{\circ}\text{C}$ )

| 参数<br>Parameter                |                                 | 符号<br>Symbol    | 额定值<br>Rating | 单位<br>Unit         |
|--------------------------------|---------------------------------|-----------------|---------------|--------------------|
| 输入<br>Input                    | 正向输入电流<br>Forward Input Current | $I_{FM}$        | 25            | mA                 |
|                                | 反向电压<br>Reverse Voltage         | $V_R$           | 5             | V                  |
| 输出<br>Output                   | 峰值输出电流<br>Peak Output Current   | $I_{O(PEAK)}$   | 3             | A                  |
|                                | 电源电压<br>Supply Voltage          | $V_{DD}-V_{SS}$ | 0~30          | V                  |
|                                | 输出电压<br>Output Voltage          | $V_O$           | 0~VDD         | V                  |
| 隔离电压<br>Isolation Voltage      |                                 | $V_{ISO}$       | 5000          | $V_{rms}$          |
| 总功耗<br>Total Power Consumption |                                 | $P_{tot}$       | 200           | mW                 |
| 工作温度<br>Operating Temperature  |                                 | $T_{opr}$       | -40~+110      | $^{\circ}\text{C}$ |
| 存储温度<br>Storage Temperature    |                                 | $T_{stg}$       | -55~+125      | $^{\circ}\text{C}$ |
| 焊接温度<br>Soldering Temperature  |                                 | $T_{sol}$       | 260           | $^{\circ}\text{C}$ |

## 推荐操作条件 Recommended Operating Conditions

| 参数<br>Parameter               | 符号<br>Symbol    | 最小值<br>Min | 最大值<br>Max. | 单位<br>Unit |
|-------------------------------|-----------------|------------|-------------|------------|
| 电源电压<br>Power Supply Voltage  | $V_{CC}-V_{SS}$ | 15         | 30          | V          |
| 开启电流<br>Input Current (ON)    | $I_{F(ON)}$     | 7          | 16          | mA         |
| 关断电压<br>Input Voltage (OFF)   | $V_{F(OFF)}$    | 0          | 0.8         | V          |
| 工作温度<br>Operating Temperature | $T_A$           | -40        | +110        | °C         |

产品特性参数 Electro-optical Characteristics ( $T_A=25^{\circ}\text{C}$ )

除非另有说明，在推荐的工作条件下测试最小值和最大值。典型值在  $T_A=25^{\circ}\text{C}$ ， $V_{DD}=30\text{V}$ ， $V_{SS}=\text{GND}$  下测量。

All minimum and maximum specifications are at recommended operating conditions, unless otherwise noted

All typical values are at  $T_A=25^{\circ}\text{C}$ ， $V_{DD}=30\text{V}$ ，and  $V_{SS}=\text{GND}$ .

| 参数<br>Parameter                            | 符号<br>Symbol        | 条件<br>Condition                                 |                         | 最小<br>Min. | 典型<br>Typ. | 最大<br>Max. | 单位<br>Unit |
|--------------------------------------------|---------------------|-------------------------------------------------|-------------------------|------------|------------|------------|------------|
| 正向电压<br>Forward Voltage                    | V <sub>F</sub>      | I <sub>F</sub> =10mA                            |                         | 1.2        | 1.5        | 1.8        | V          |
| 反向电流<br>Reverse Current                    | I <sub>R</sub>      | V <sub>R</sub> =5V                              |                         | -          | -          | 10         | μA         |
| 高电平输出电流<br>High Level Output Current       | I <sub>OH</sub>     | V <sub>O</sub> =VDD-3V                          |                         | -1.0       | -2.0       | -2.5       | A          |
|                                            |                     | V <sub>O</sub> =VDD-6V                          |                         | -2.0       | -          | -2.5       |            |
| 低电平输出电流<br>Low Level Output Current        | I <sub>OL</sub>     | V <sub>O</sub> =VSS+3V                          |                         | 1.0        | 2.0        | 2.5        | A          |
|                                            |                     | V <sub>O</sub> =VSS+6V                          |                         | 2.0        | -          | 2.5        |            |
| 高电平输出电压<br>High Level Output Voltage       | V <sub>OH</sub>     | I <sub>F</sub> =10mA                            | I <sub>O</sub> = -2.5A  | VDD-6.25V  | VDD-2.5V   | -          | V          |
|                                            |                     |                                                 | I <sub>O</sub> = -100mA | VDD-0.3V   | VDD-0.1V   | -          |            |
| 低电平输出电压<br>Low Level Output Voltage        | V <sub>OL</sub>     | I <sub>F</sub> =0mA                             | I <sub>O</sub> = 2.5A   | -          | VSS+2.5V   | VSS+6.25V  | V          |
|                                            |                     |                                                 | I <sub>O</sub> = 100mA  | -          | VSS+0.1V   | VSS+0.3V   |            |
| 高电平电源电流<br>High Level Power Supply Current | I <sub>DDH</sub>    | V <sub>O</sub> =Open, I <sub>F</sub> =7 to 16mA |                         | -          | 1.8        | 3.8        | mA         |
| 低电平电源电流<br>Low Level Power Supply Current  | I <sub>DDL</sub>    | V <sub>O</sub> =Open, V <sub>F</sub> =0 to 0.8V |                         | -          | 2.1        | 3.8        | mA         |
| 输入开启电流<br>Input The Turn On Current        | I <sub>FLH</sub>    | I <sub>O</sub> =0mA, V <sub>O</sub> >5V         |                         | -          | 2.8        | 5.0        | mA         |
| 输入关闭电压<br>Input The Turn Off Voltage       | V <sub>FHL</sub>    | I <sub>O</sub> =0mA, V <sub>O</sub> <5V         |                         | 0.8        | -          | -          | V          |
| 低电压锁定阈值<br>UVLO Threshold                  | V <sub>UVLO+</sub>  | I <sub>F</sub> =10mA, V <sub>O</sub> >5V        |                         | 11.5       | 12.7       | 13.5       | V          |
|                                            | V <sub>UVLO-</sub>  | I <sub>F</sub> =10mA, V <sub>O</sub> <5V        |                         | 10.0       | 11.2       | 12         | V          |
| 低电压锁定阈值迟滞<br>UVLO Hysteresis               | UVLO <sub>HYS</sub> | -                                               |                         | -          | 1.5        | -          | V          |

|                                                                  |                 |                                                                                        |      |           |     |             |
|------------------------------------------------------------------|-----------------|----------------------------------------------------------------------------------------|------|-----------|-----|-------------|
| 隔离电阻<br>Isolation Resistance                                     | $R_{ISO}$       | $V_{I-O}=500V$ , 40~60%R.H.                                                            | -    | $10^{11}$ | -   | $\Omega$    |
| 隔离电容<br>Isolation Capacitance                                    | $C_{ISO}$       | $V_{I-O}=0V$ , Freq=1MHz                                                               |      | 1         |     | pF          |
| 逻辑低电平传输延迟<br>Propagation Delay Time<br>to Low Output Level       | $T_{PHL}$       | $I_F=7mA$ to $16mA$ ,<br>$R_g=10\Omega$ ,<br>$C_g=10nF$ ,<br>$F=10KHz$ ,<br>占空比=50%    | -    | 71        | 400 | ns          |
| 逻辑低电平传输延迟<br>Propagation Delay Time<br>to High Output Level      | $T_{PLH}$       |                                                                                        | -    | 68        | 400 | ns          |
| 脉冲失真<br>Pulse Width Distortion                                   | PWD             |                                                                                        | -    | 3         | 100 | ns          |
| 传播延迟差<br>Propagation Delay Diference<br>Between Any Two Parts    | PDD             |                                                                                        | -250 | -         | 250 | ns          |
| 输出上升时间(10%~90%)<br>Output Rise Time (10% To 90%)                 | $T_R$           | $I_F=7mA$ to $16mA$ ,<br>$R_g=10\Omega$ ,<br>$C_g=10nF$ ,<br>$F=10KHz$ ,<br>占空比=50%    | -    | 60        | -   | ns          |
| 输出下降时间(90%~10%)<br>Output Drop Time(90%~10%)                     | $T_F$           |                                                                                        | -    | 60        | -   | ns          |
| UVLO 开启延迟<br>UVLO Turn On Delay                                  | $T_{UVLO\ ON}$  | $I_F=10mA$ , $V_O > 5V$                                                                | -    | 1.6       | -   | $\mu s$     |
| UVLO 关闭延迟<br>UVLO Turn Off Delay                                 | $T_{UVLO\ OFF}$ | $I_F=10mA$ , $V_O < 5V$                                                                | -    | 0.4       | -   | $\mu s$     |
| 输出高电平共模抑制<br>Output High Level Common Mode<br>Transient Immunity | $ CM_H $        | $T_A = 25^\circ C$<br>$V_{DD} = 30V$<br>$V_{CM}=2000V$<br>$I_F=7\sim 16mA$<br>$V_F=0V$ | 35   | 50        | -   | KV/ $\mu s$ |
| 输出低电平共模抑制<br>Output Low Level Common Mode<br>Transient Immunity  | $ CM_L $        | $T_A = 25^\circ C$<br>$V_{DD} = 30V$<br>$V_{CM}=2000V$<br>$I_F=7\sim 16mA$<br>$V_F=0V$ | 35   | 50        | -   | KV/ $\mu s$ |

### 典型光电特性曲线 Typical Electro-Optical Characteristics Curves

Fig.1 High Output Rail Voltage vs Ambient Temperature

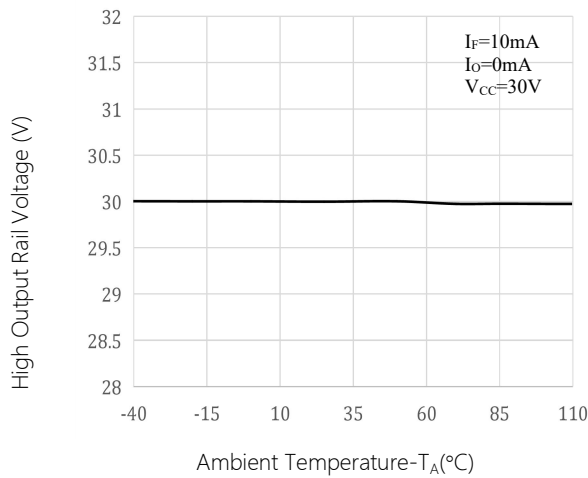


Fig.2 High Level Output Voltage vs Ambient Temperature

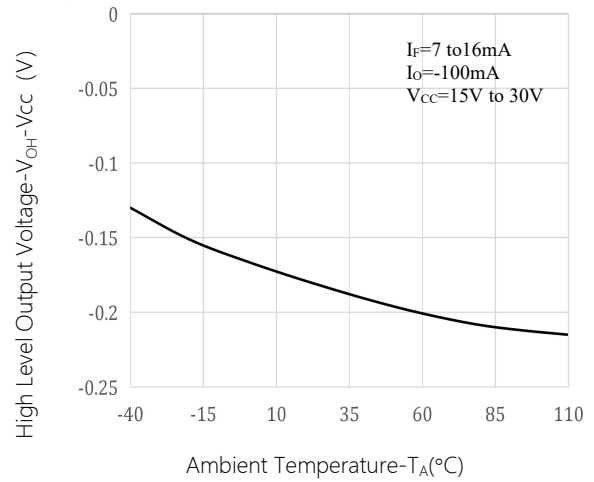


Fig.3 Low Level Output Voltage vs Ambient Temperature

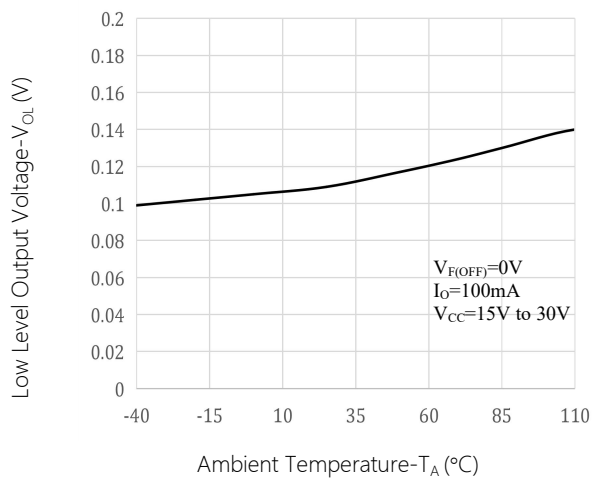


Fig.4 Supply Current vs Ambient Temperature

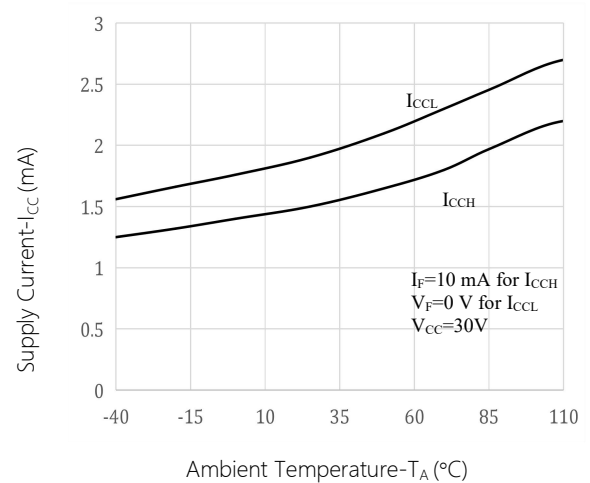


Fig.5 Supply Current vs Supply Voltage

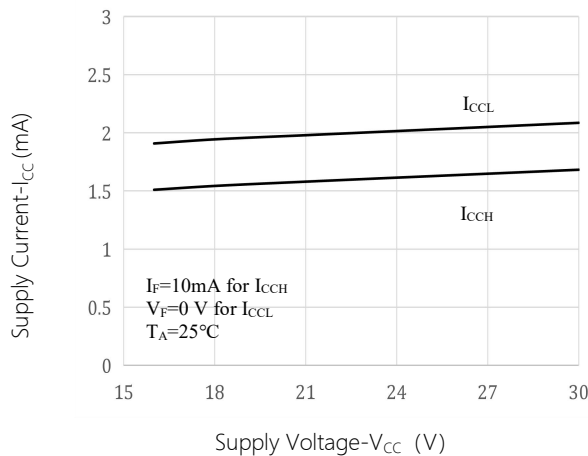


Fig.6 Output Voltage vs Threshold Input Current Low to High

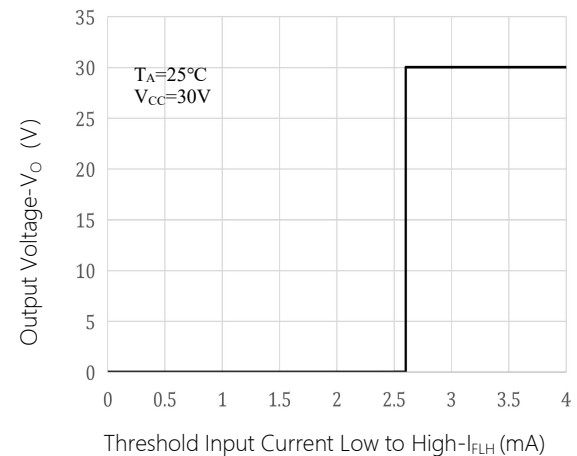


Fig.7 Threshold Input Current Low to High vs Ambient Temperature

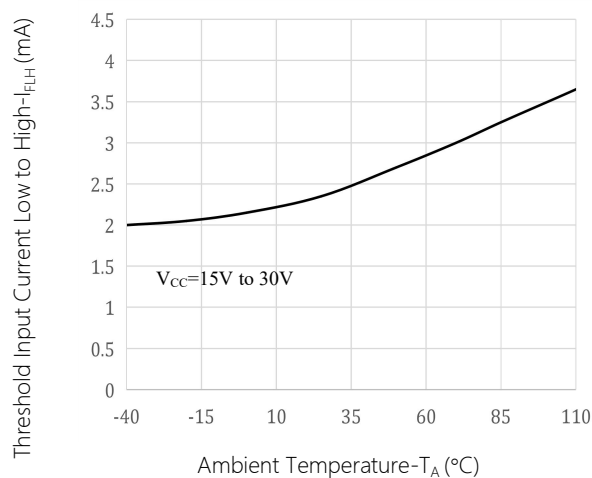


Fig.8 Propagation Delay vs Supply Voltage

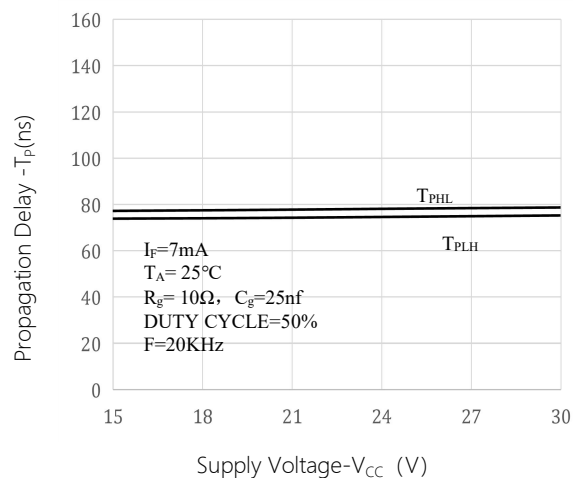


Fig.9 Propagation Delay vs Forward Current

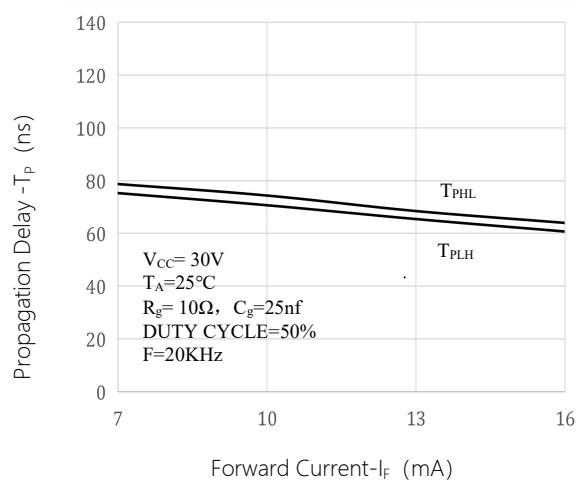


Fig.10 Propagation Delay vs Ambient Temperature

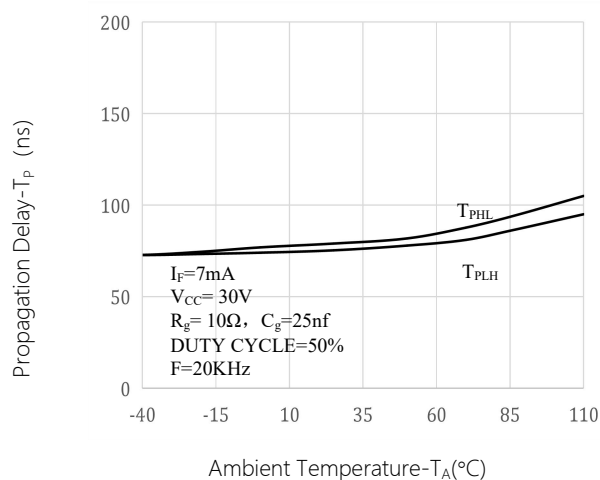
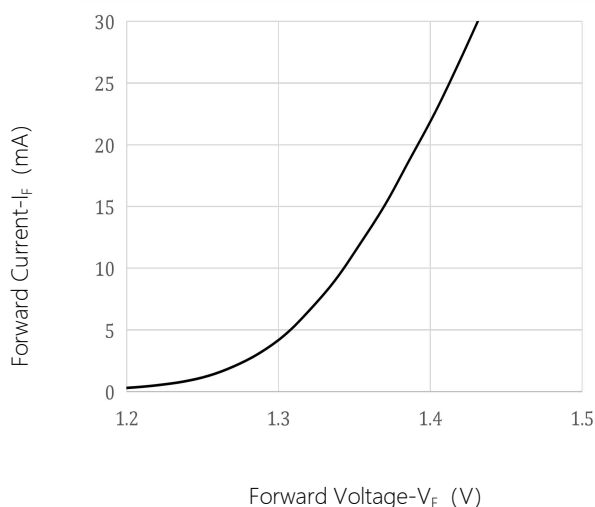


Fig.11 Forward Current vs Forward Voltage



测试电路图 Test Circuits Diagrams

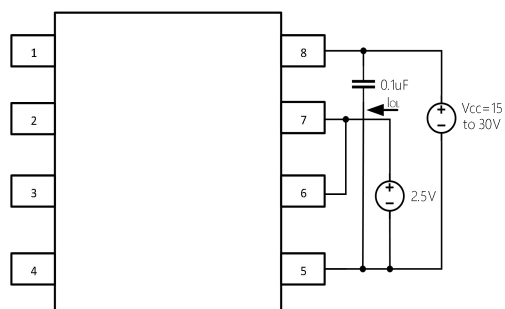


Figure.12  $I_{OL}$  Pulsed Test Circuit

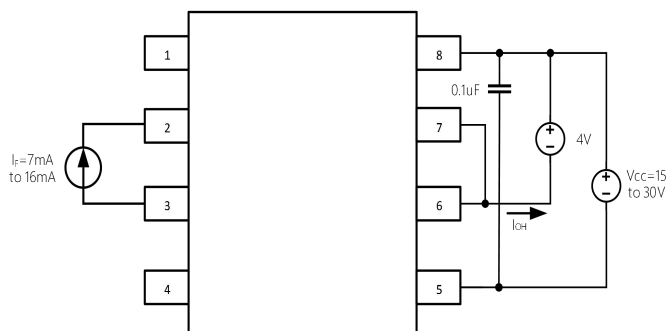


Figure.13  $I_{OH}$  Pulsed Test Circuit

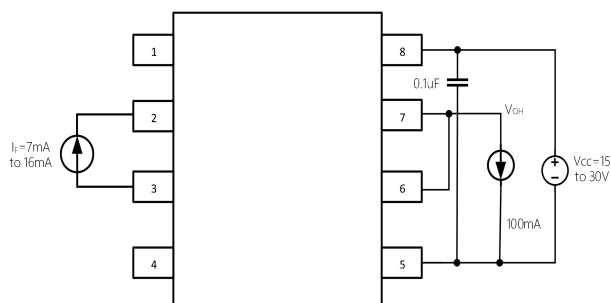


Figure.14  $V_{OH}$  Pulsed Test Circuit

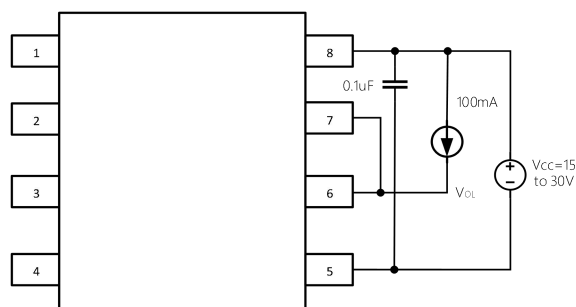


Figure.15  $V_{OL}$  Pulsed Test Circuit

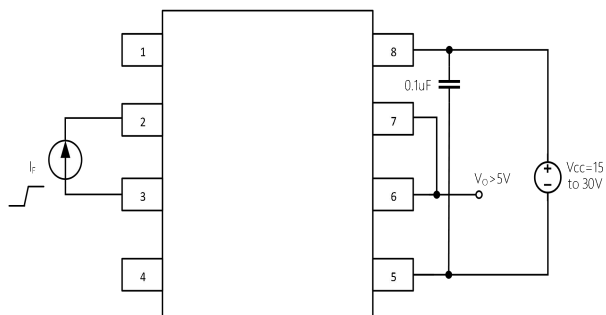


Figure.16  $I_{FLH}$  Test Circuit

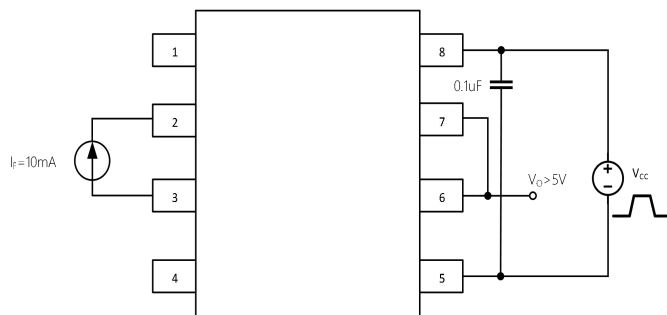


Figure.17 UVLO Test Circuit



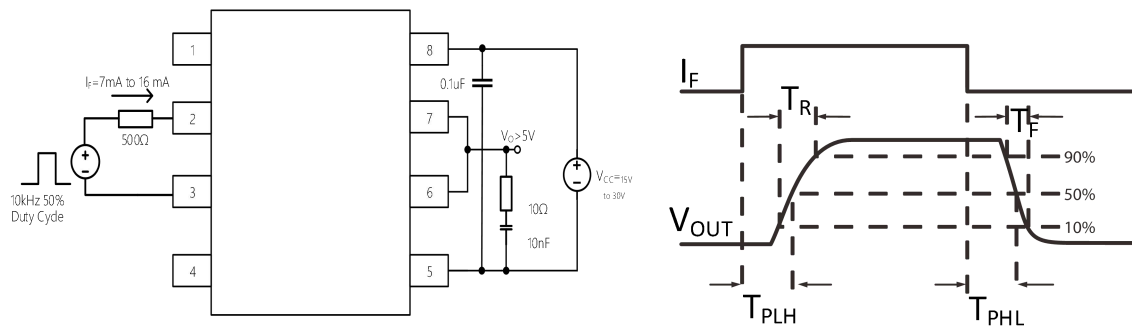


Figure.18  $T_{PHL}$ 、 $T_{PLH}$ 、 $T_R$ 、 $T_F$  Test Circuit

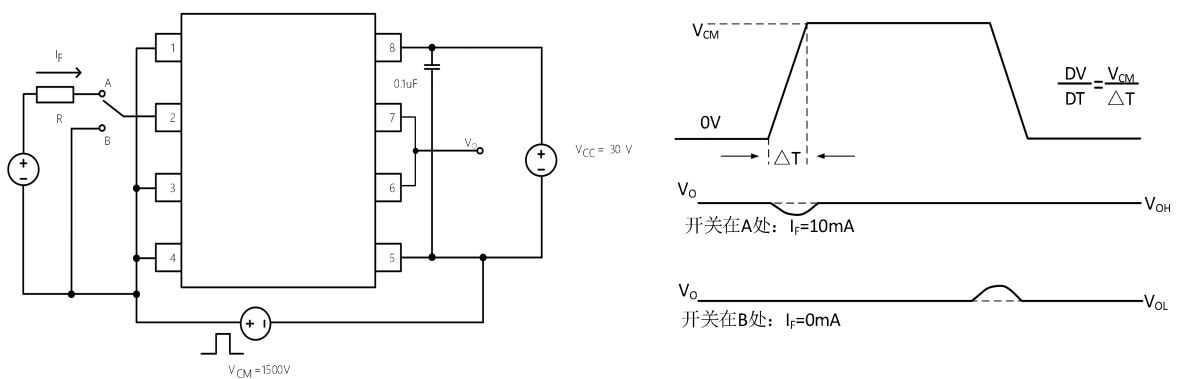
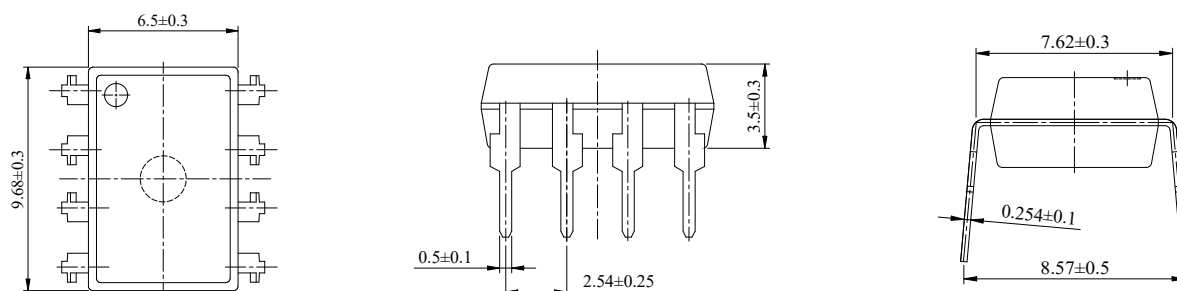


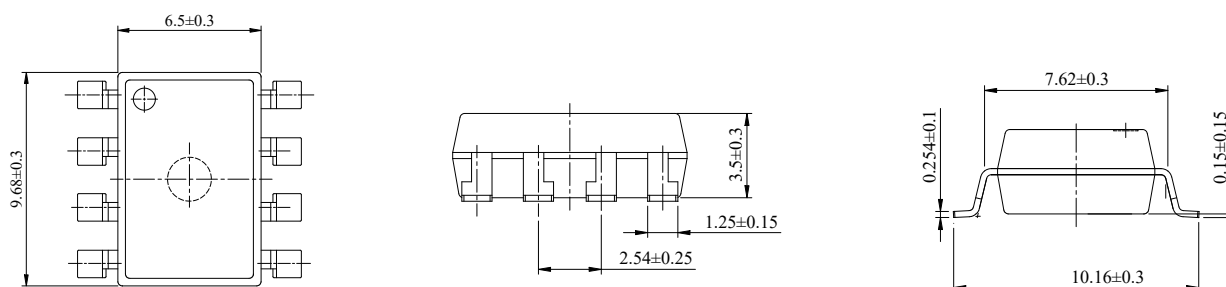
Figure.19 CMR Test Circuit

### 外形尺寸 Outline Dimensions

DIP8

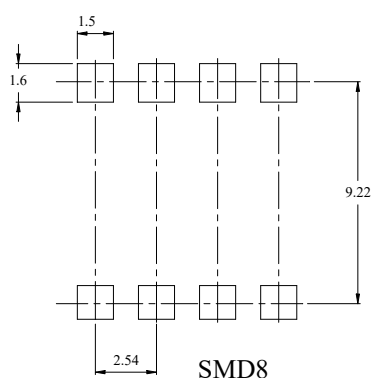


SMD8



单位 Unit: mm

### 建议焊盘布局 Recommended Pad Layout

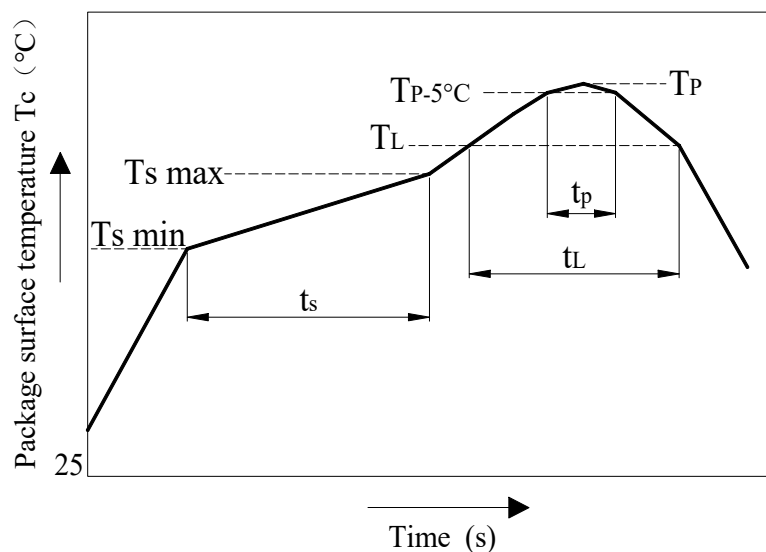


单位 Unit: mm

注：上图为产品正视图。

Note: The picture above is the front view of the product.

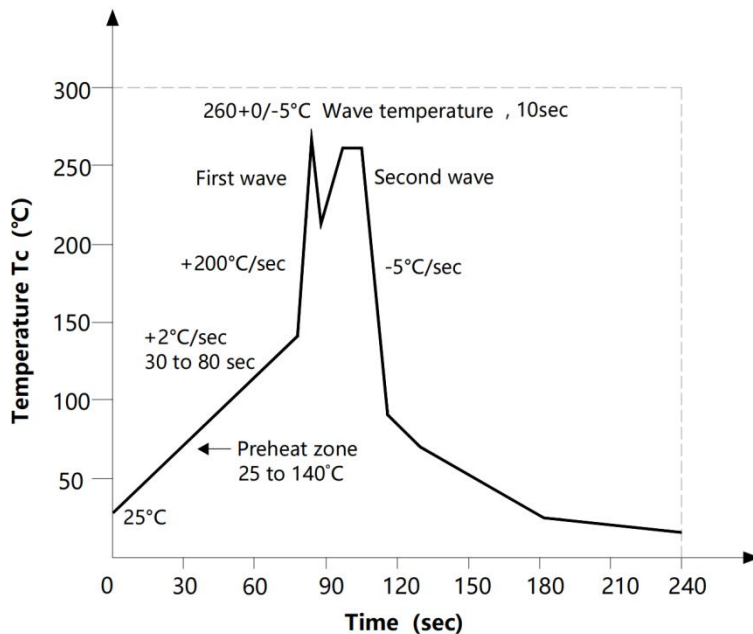
## 回流焊温度曲线图 Solder Reflow Profile



| 项目<br>Item                                                                                | 符号<br>Symbol | 最小值<br>Min. | 最大值<br>Max. | 单位<br>Unit         |
|-------------------------------------------------------------------------------------------|--------------|-------------|-------------|--------------------|
| 预热温度<br>Preheat Temperature                                                               | $T_s$        | 150         | 200         | $^\circ\text{C}$   |
| 预热时间<br>Preheat Time                                                                      | $t_s$        | 60          | 120         | s                  |
| 升温速率<br>Ramp-Up Rate ( $T_L$ to $T_P$ )                                                   | -            | -           | 3           | $^\circ\text{C/s}$ |
| 液相线温度<br>Liquidus Temperature                                                             | $T_L$        | 217         |             | $^\circ\text{C}$   |
| 时间高于 $T_L$<br>Time Above $T_L$                                                            | $t_L$        | 60          | 150         | s                  |
| 峰值温度<br>Peak Temperature                                                                  | $T_P$        | -           | 260         | $^\circ\text{C}$   |
| $T_c$ 在 $(T_P-5)$ 和 $T_P$ 之间的时间<br>Time During Which $T_c$ Is Between $(T_P-5)$ and $T_P$ | $t_p$        | -           | 30          | s                  |
| 降温速率<br>Ramp-down Rate ( $T_P$ to $T_L$ )                                                 | -            | -           | 6           | $^\circ\text{C/s}$ |

注：建议在所示的温度和时间条件下进行回流焊，最多不能超过三次。

Note: Reflow soldering is recommended at the temperatures and times shown, no more than three times.

**波峰焊温度曲线图 Wave Soldering Profile****手工烙铁焊接 Soldering with hand soldering iron**

A. 手工烙铁焊仅用于产品返修或样品测试;

Hand soldering iron is only used for product rework or sample testing;

B. 手工烙铁焊要求: 温度  $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$ , 时间  $\leq 3\text{s}$ 。

Manual soldering method Temperature:  $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$ , within 3s.

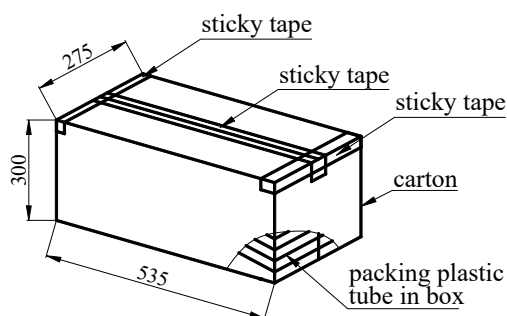
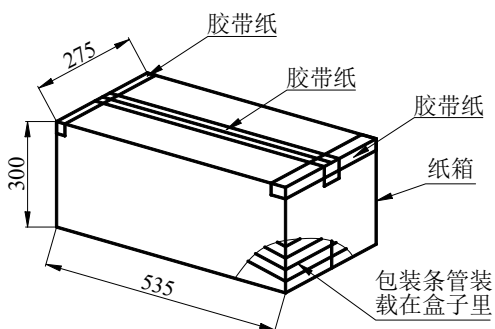
## 包装 Packing

## ■ 汇总表 Summary table

| 封装形式         | 包装方式                                | 盘数量               | 盒数量              | 箱数量                 | 静电袋规格                        | 盒规格               | 箱(双瓦楞)规格             | 备注                                                                        |
|--------------|-------------------------------------|-------------------|------------------|---------------------|------------------------------|-------------------|----------------------|---------------------------------------------------------------------------|
| SMD8         | 卷盘<br>( $\phi 330\text{mm}$ 蓝盘)     | 1k/盘              | 2 盘/盒            | 10 盒/箱              | 450*390*0.1mm                | 340*60*340mm      | 380*360*365mm        | 首端空 50 个空格, 末端空 100                                                       |
| DIP8         | 管装<br>(500*12*11mm)                 | 45/管              | 50 管/盒           | 10 盒/箱              | 不适用                          | 525*128*56mm      | 535*275*300mm        | 每管使用蓝白胶塞, 方向须一致                                                           |
| Package Type | Packing Form                        | Quantity per Reel | Quantity per Box | Quantity per Carton | Antistatic Bag Specification | Box Specification | Carton Specification | Note                                                                      |
| SMD8         | Tube<br>( $\phi 330\text{mm}$ Blue) | 1k pcs/reel       | 2 reels /box     | 10 boxes /ctn       | 450*390*0.1mm                | 340*60*340mm      | 380*360*365mm        | Leave 50 Spaces at the beginning and 100 Spaces at the end                |
| DIP8         | Reel<br>(500*12*11mm)               | 45 pcs/Tube       | 50 Tubes/box     | 10 boxes/ctn        | Not applicable               | 525*128*56mm      | 535*275*300mm        | Use blue and white rubber stoppers for each tube, with the same direction |

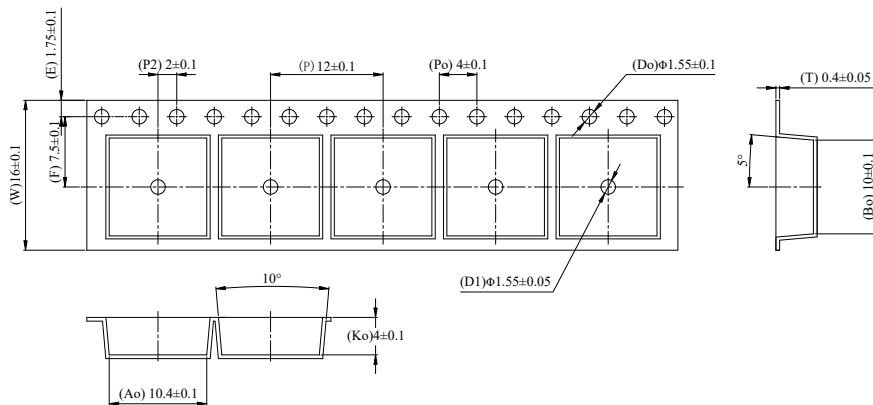
## ■ 管条包装 Tape &amp; Tube

- 1) 每管数量: 45 只。  
Qty/Tube: 45 pcs.
- 2) 每箱数量: 22500 只。  
Qty/ctn: 22500 pcs.
- 3) 内包装: 每盒 50 管。  
Inner packing: 50 Tubes/box.
- 4) 示意图 Schematic:



### ■ 编带包装 Tape & Reel

- 1) 每卷数量: 1000 只。  
Qty/reel: 1000 pcs.
- 2) 每箱数量: 20000 只。  
Qty/ctn: 20000 pcs.
- 3) 内包装: 每盒 2 盘。  
Inner packing: 2 reels/box.
- 4) 示意图 Schematic:



单位 Unit: mm

### 注意 Attention

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